

# BAR64-02V

## Single RF PIN diode



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Technical documents



Simulation



Support

## Product description

This Infineon RF PIN diode provides high-voltage handling capabilities, comes with low loss and offers low distortion levels. Its low forward resistance, low capacitance and low inductance simplify design-in and support designers in creating versatile end-solutions.



## Feature list

- Very low capacitance  $C = 0.13 \text{ pF}$  (typical) at voltage  $V_R = 0 \text{ V}$  and frequencies  $f \geq 1 \text{ GHz}$
- Low forward resistance  $R_F = 2.4 \Omega$  (typical) at forward current  $I_F = 10 \text{ mA}$  and frequency  $f = 2.5 \text{ GHz}$
- Low signal distortion
- Industry standard SC79 package (1.6 mm x 0.8 mm x 0.55 mm)
- Pb-free, RoHS compliant and halogen-free

## Product validation

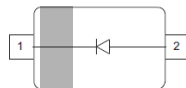
Qualified for industrial applications according to the relevant tests of JEDEC47/20/22.

## Potential applications

Optimized for low bias current RF and high-speed interface switches in:

- Wireless communications
- High speed data networks

## Device information



**Table 1** Part information

Product name / Ordering code	Package	Pin configuration	Marking	Pieces / Reel
BAR64-02V / BAR6402VH6327XTSA1	SC79	Single, with leads	0	3 k

**Attention:** *ESD (Electrostatic discharge) sensitive device, observe handling precautions!*

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**1 Absolute maximum ratings**

**Table 2 Absolute maximum ratings at  $T_A = 25\text{ °C}$ , unless otherwise specified**

Parameter	Symbol	Values		Unit	Note or test condition
		Min.	Max.		
Diode reverse voltage	$V_R$	–	150	V	
Forward current	$I_F$	–	100	mA	
Total power dissipation	$P_{TOT}$	–	250	mW	$T_S \leq 125\text{ °C}$ <sup>1)</sup>
Junction temperature	$T_J$	–	150	°C	
Operating temperature	$T_{OP}$	-55	125		
Storage temperature	$T_{STG}$	-55	150		

**Attention:** Stresses above the maximum values listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Exceeding only one of these values may cause irreversible damage to the component.

<sup>1</sup>  $T_S$  is the soldering point temperature.

**Electrical performance in test fixture**

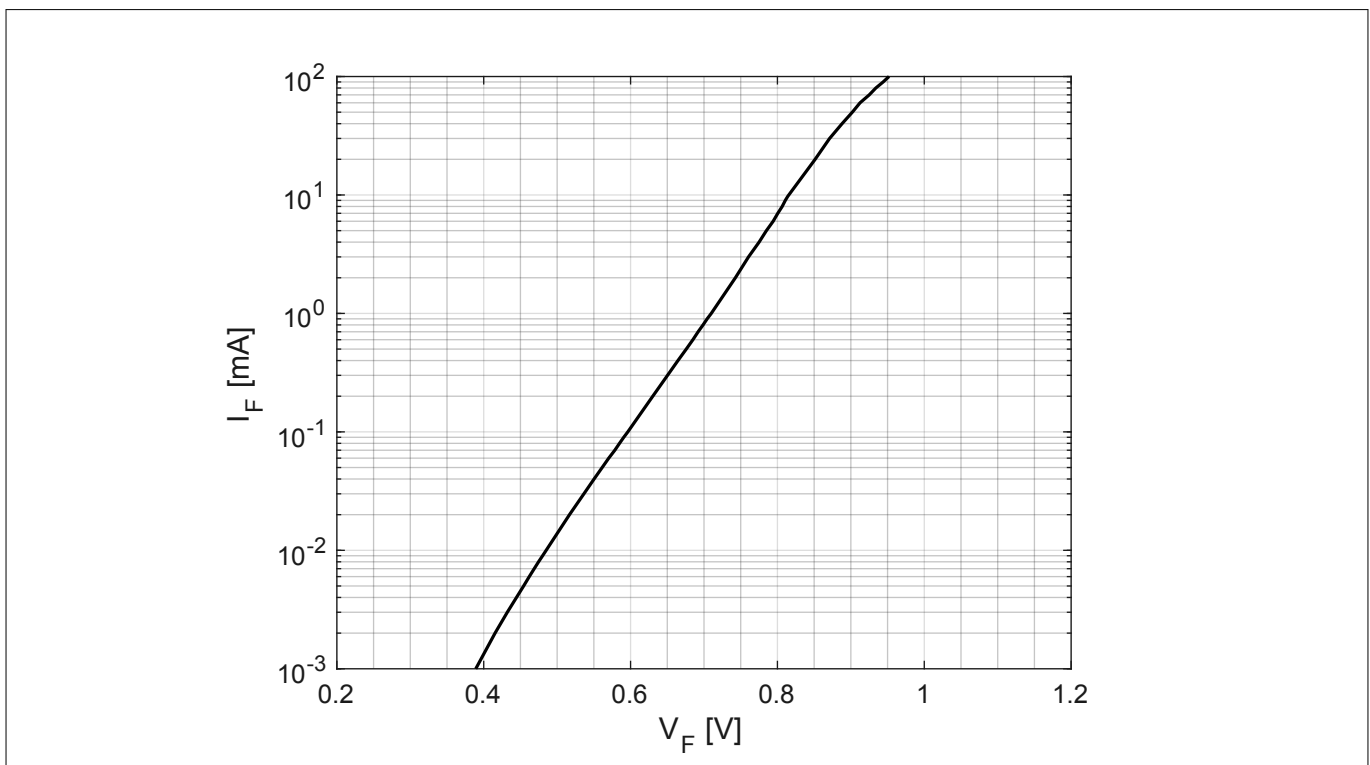
**2 Electrical performance in test fixture**

**2.1 DC characteristics**

At  $T_A = 25\text{ }^\circ\text{C}$ , unless otherwise specified

**Table 3 DC characteristics**

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Breakdown voltage	$V_{BR}$	150	–	–	V	$I_R = 5\text{ }\mu\text{A}$
Reverse current	$I_R$	–	–	20	nA	$V_R = 20\text{ V}$
Forward voltage	$V_F$	–	0.82	–	V	$I_F = 10\text{ mA}$
		–	0.9	–		$I_F = 50\text{ mA}$
		–	0.95	1.1		$I_F = 100\text{ mA}$
I-region width	$W_1$	–	50	–	$\mu\text{m}$	



**Figure 1 Forward current  $I_F$  vs. forward voltage  $V_F$**

**Electrical performance in test fixture**

**2.2 AC characteristics**

At  $T_A = 25\text{ °C}$ , unless otherwise specified

**Table 4 Key parameter**

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Capacitance	C	–	0.56	–	pF	$V_R = 0\text{ V}, f = 1\text{ MHz}$
		–	0.2	0.35		$V_R = 20\text{ V}, f = 1\text{ MHz}$
Forward resistance	$R_F$	–	10.1	20	$\Omega$	$I_F = 1\text{ mA}, f = 100\text{ MHz}$
		–	4.3	–		$I_F = 3\text{ mA}, f = 100\text{ MHz}$
		–	3.1	–		$I_F = 5\text{ mA}, f = 100\text{ MHz}$
		–	2.1	2.8		$I_F = 10\text{ mA}, f = 100\text{ MHz}$
		–	–	1.35		$I_F = 100\text{ mA}, f = 100\text{ MHz}$
Inductance	$L_S$	–	0.6	–	nH	
Charge carrier lifetime	$\tau_{rr}$	–	1550	–	ns	$I_F = 10\text{ mA}, I_R = 6\text{ mA}$ , measured at $I_R = 3\text{ mA}$ , $R_L = 100\ \Omega$

**Table 5 AC parameter at  $f = 1\text{ GHz}$**

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Capacitance	C	–	0.13	–	pF	$V_R = 0\text{ V}$
Reverse parallel resistance	$R_P$	–	3.9	–	k $\Omega$	$V_R = 0\text{ V}$
Forward resistance	$R_F$	–	9.6	–	$\Omega$	$I_F = 1\text{ mA}$
		–	4.3	–		$I_F = 3\text{ mA}$
		–	3.1	–		$I_F = 5\text{ mA}$
		–	2.2	–		$I_F = 10\text{ mA}$
Insertion loss	$I_L$	–	0.79	–	dB	$I_F = 1\text{ mA}$
		–	0.37	–		$I_F = 3\text{ mA}$
		–	0.28	–		$I_F = 5\text{ mA}$
		–	0.2	–		$I_F = 10\text{ mA}$
Isolation	$I_{SO}$	–	22.4	–		$V_R = 0\text{ V}$

**Table 6 AC parameter at  $f = 1.8\text{ GHz}$**

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Capacitance	C	–	0.12	–	pF	$V_R = 0\text{ V}$
Reverse parallel resistance	$R_P$	–	3.3	–	k $\Omega$	$V_R = 0\text{ V}$

**Electrical performance in test fixture**

**Table 6 AC parameter at  $f = 1.8$  GHz (continued)**

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Forward resistance	$R_F$	-	9.6	-	$\Omega$	$I_F = 1$ mA
		-	4.3	-		$I_F = 3$ mA
		-	3.2	-		$I_F = 5$ mA
		-	2.3	-		$I_F = 10$ mA
Insertion loss	$I_L$	-	0.8	-	dB	$I_F = 1$ mA
		-	0.39	-		$I_F = 3$ mA
		-	0.3	-		$I_F = 5$ mA
		-	0.23	-		$I_F = 10$ mA
Isolation	$I_{SO}$	-	17.7	-		$V_R = 0$ V

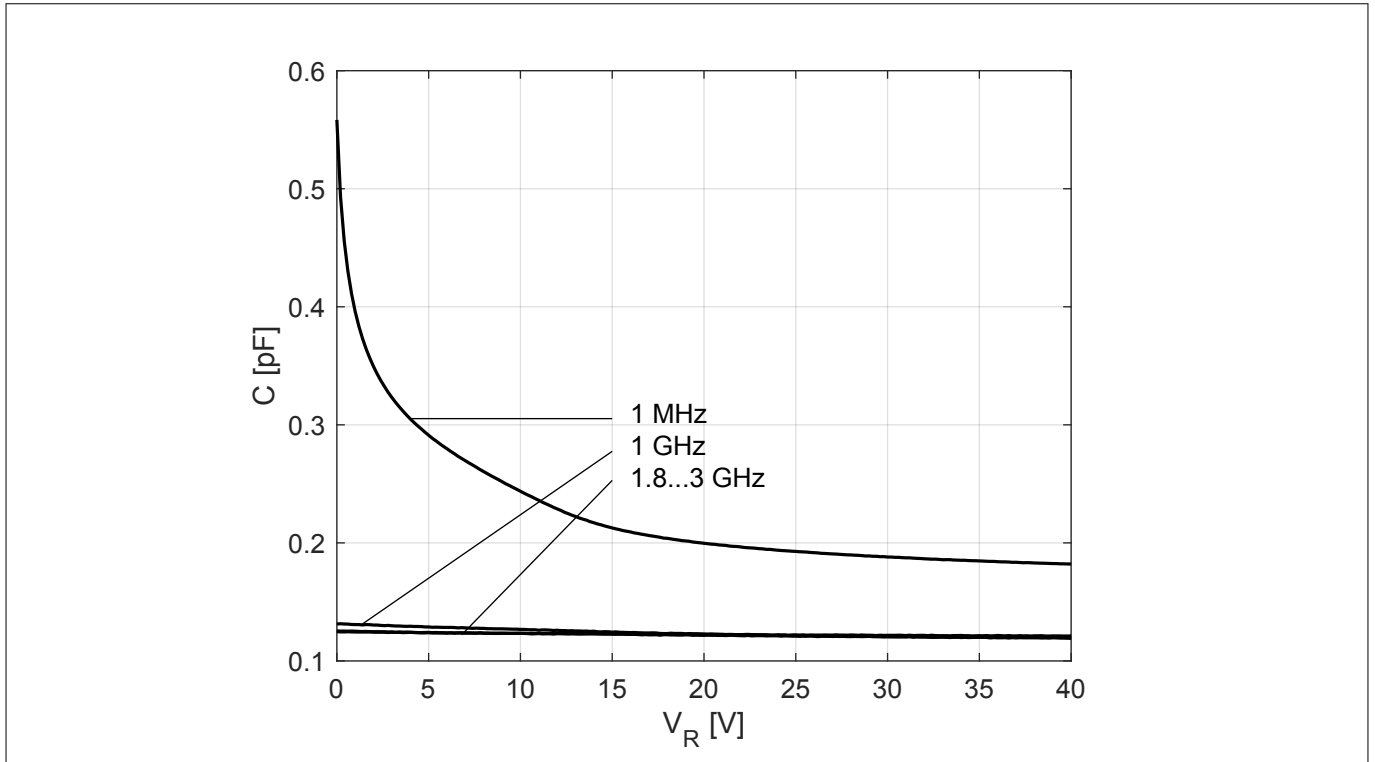
**Table 7 AC parameter at  $f = 2.5$  GHz**

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Capacitance	$C$	-	0.12	-	pF	$V_R = 0$ V
Reverse parallel resistance	$R_P$	-	3	-	k $\Omega$	$V_R = 0$ V
Forward resistance	$R_F$	-	9.7	-	$\Omega$	$I_F = 1$ mA
		-	4.4	-		$I_F = 3$ mA
		-	3.3	-		$I_F = 5$ mA
		-	2.4	-		$I_F = 10$ mA
Insertion loss	$I_L$	-	0.82	-	dB	$I_F = 1$ mA
		-	0.42	-		$I_F = 3$ mA
		-	0.33	-		$I_F = 5$ mA
		-	0.26	-		$I_F = 10$ mA
Isolation	$I_{SO}$	-	15.1	-		$V_R = 0$ V

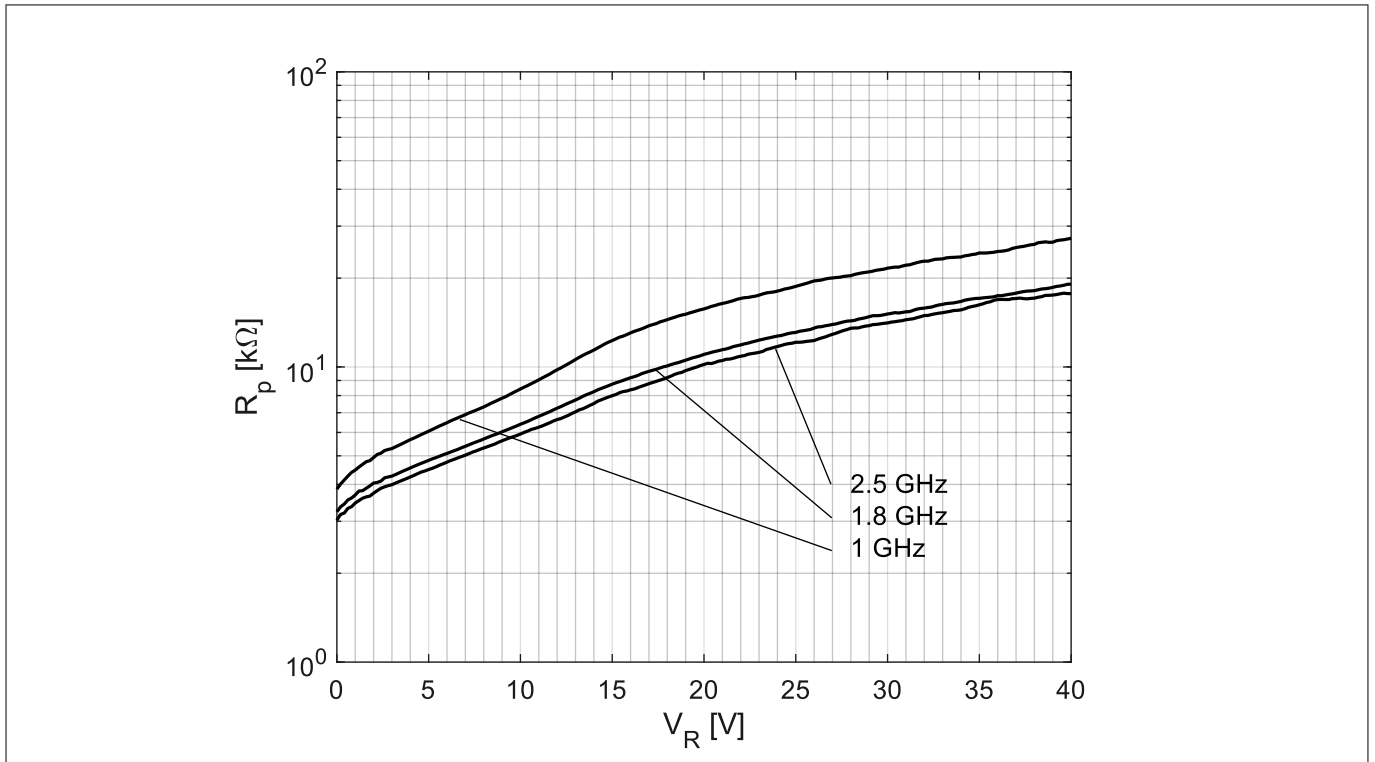
**Table 8 AC parameter at  $f = 5.5$  GHz**

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Insertion loss	$I_L$	-	1.03	-	dB	$I_F = 1$ mA
		-	0.64	-		$I_F = 3$ mA
		-	0.56	-		$I_F = 5$ mA
		-	0.49	-		$I_F = 10$ mA
Isolation	$I_{SO}$	-	7.7	-		$V_R = 0$ V

**Electrical performance in test fixture**

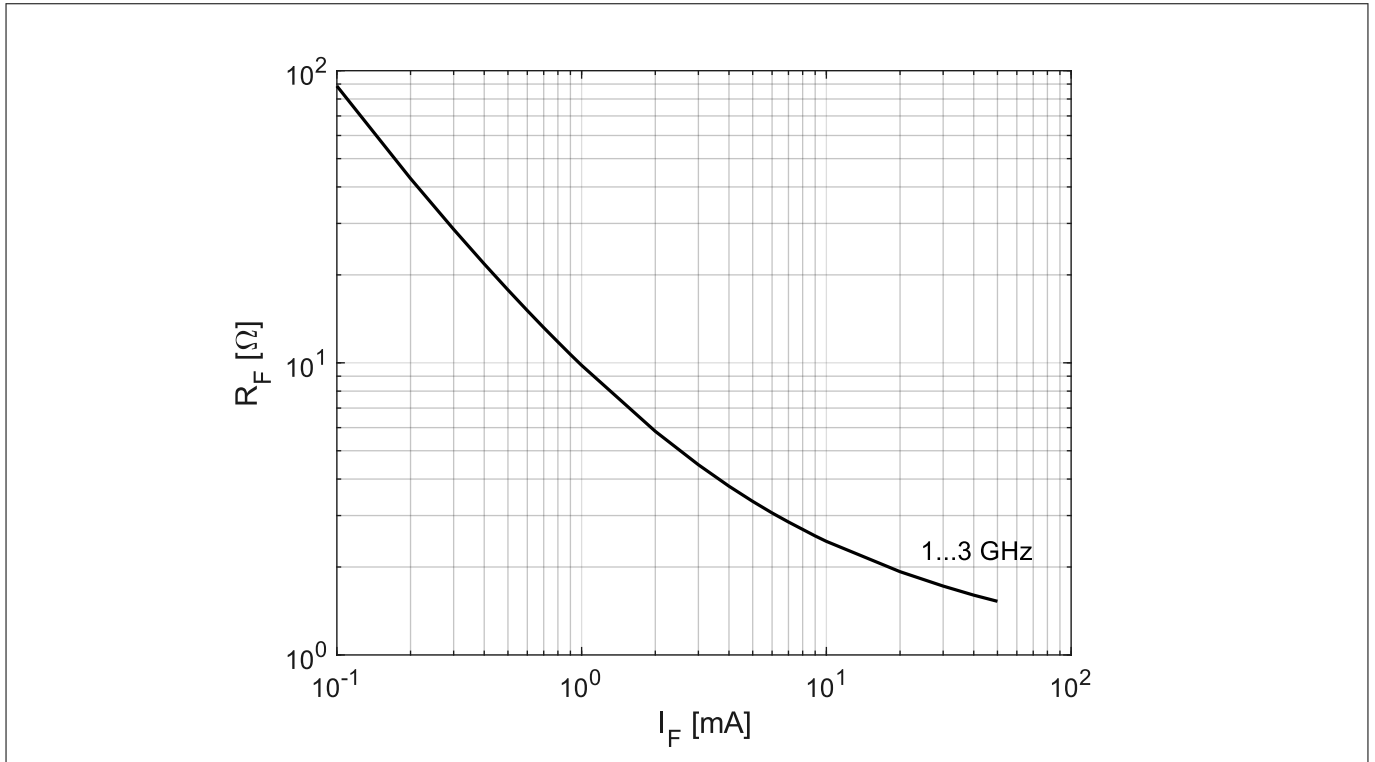


**Figure 2** Capacitance C vs. reverse voltage V<sub>R</sub> at different frequencies

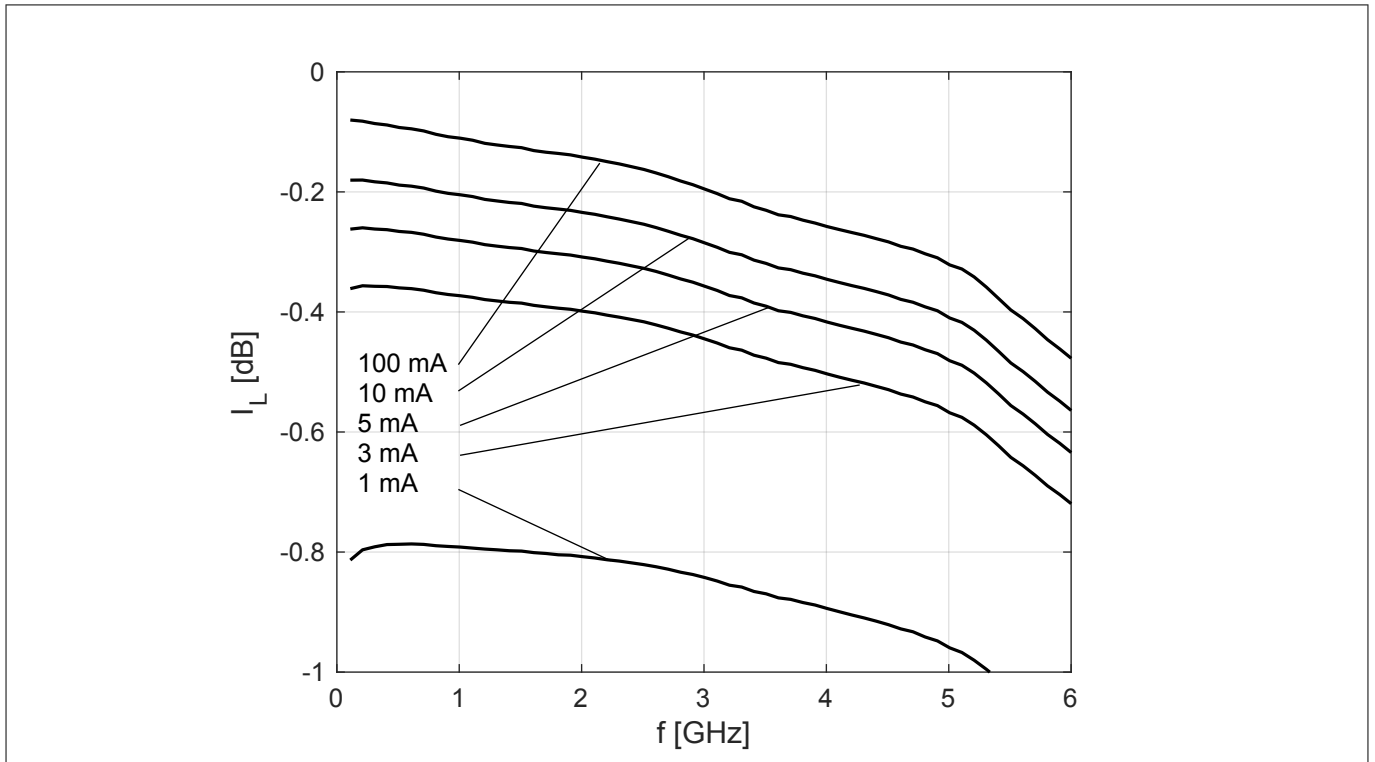


**Figure 3** Reverse parallel resistance R<sub>p</sub> vs. reverse voltage V<sub>R</sub> at different frequencies

**Electrical performance in test fixture**

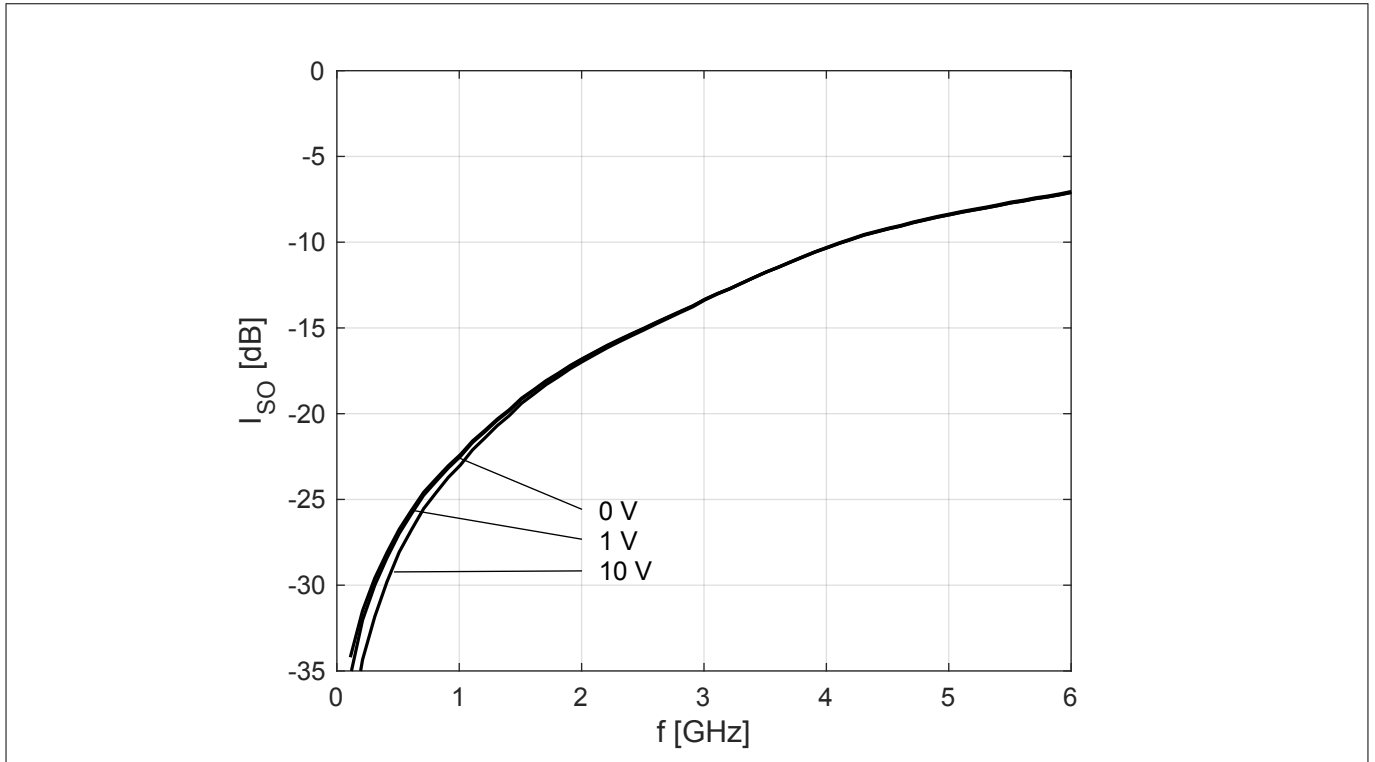


**Figure 4** Forward resistance  $R_F$  vs. forward current  $I_F$  at different frequencies



**Figure 5** Insertion loss  $I_L$  vs. frequency  $f$  at different forward currents

**Electrical performance in test fixture**



**Figure 6** Isolation  $I_{50}$  vs. frequency  $f$  at different reverse voltages

*Note:* The curves shown in this chapter have been generated using typical devices but shall not be understood as a guarantee that all devices have identical characteristic curves.

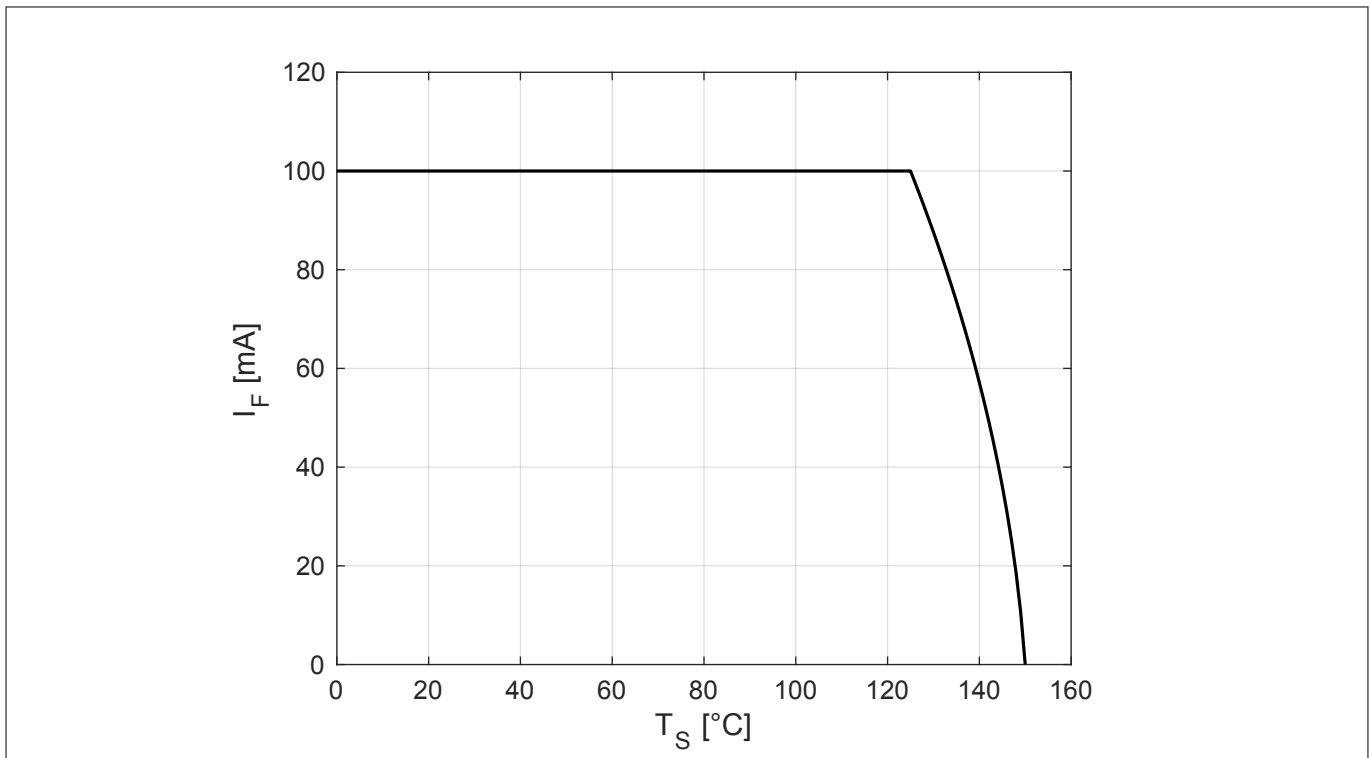


Thermal characteristics

### 3 Thermal characteristics

**Table 9** Thermal resistance

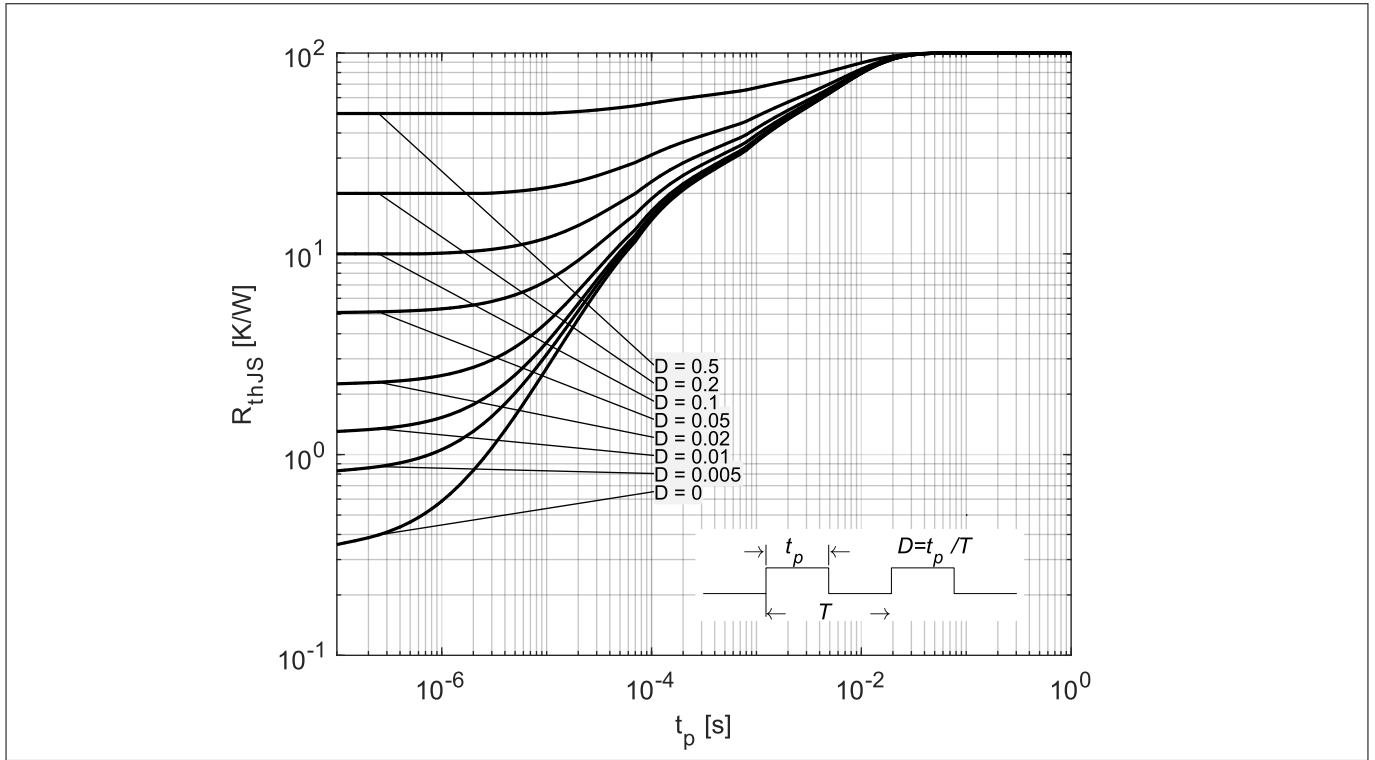
Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Thermal resistance (junction - soldering point)	$R_{thJS}$	-	100	-	K/W	$T_S = 125\text{ °C}$ <sup>1)</sup>



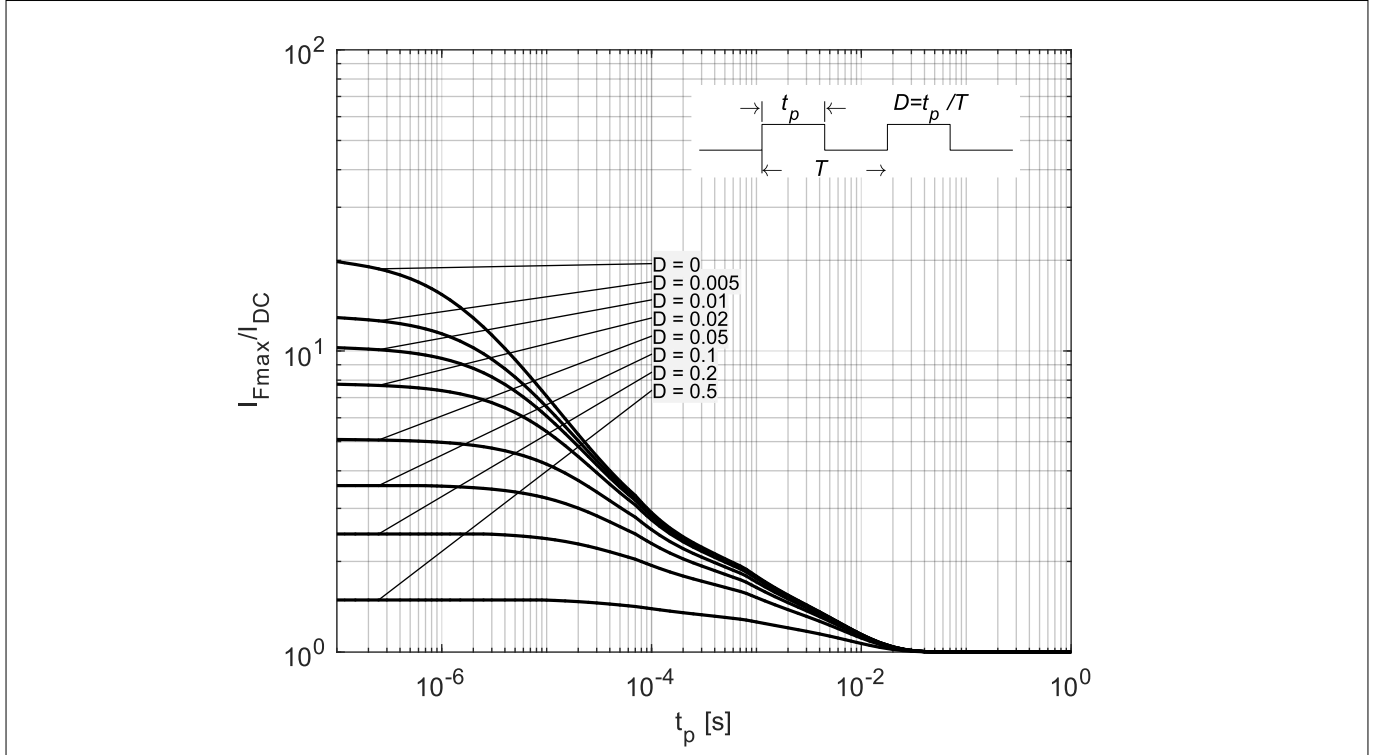
**Figure 7** Permissible forward current  $I_F$  in DC operation

<sup>1</sup> For  $R_{thJS}$  in other conditions refer to the curves in this chapter.

**Thermal characteristics**



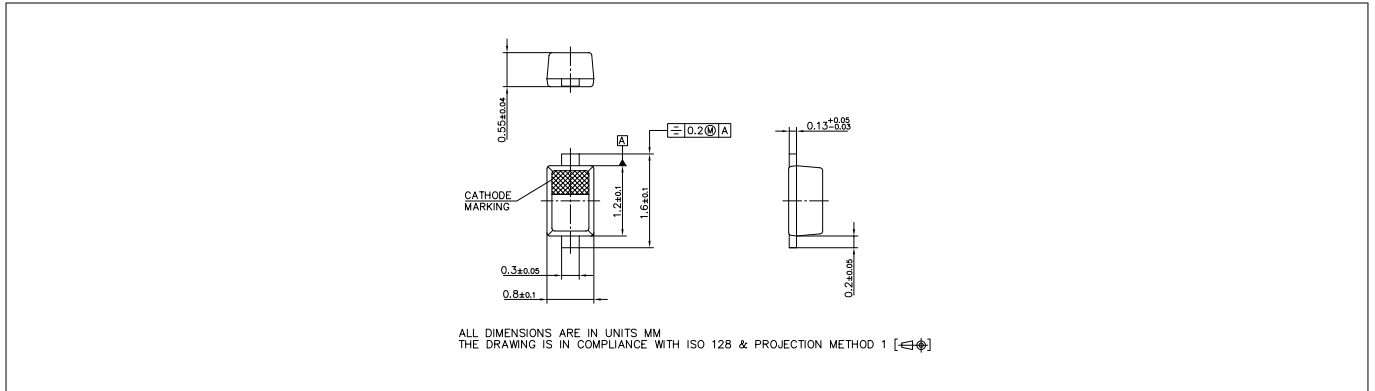
**Figure 8 Thermal resistance  $R_{thJS}$  in pulse operation**



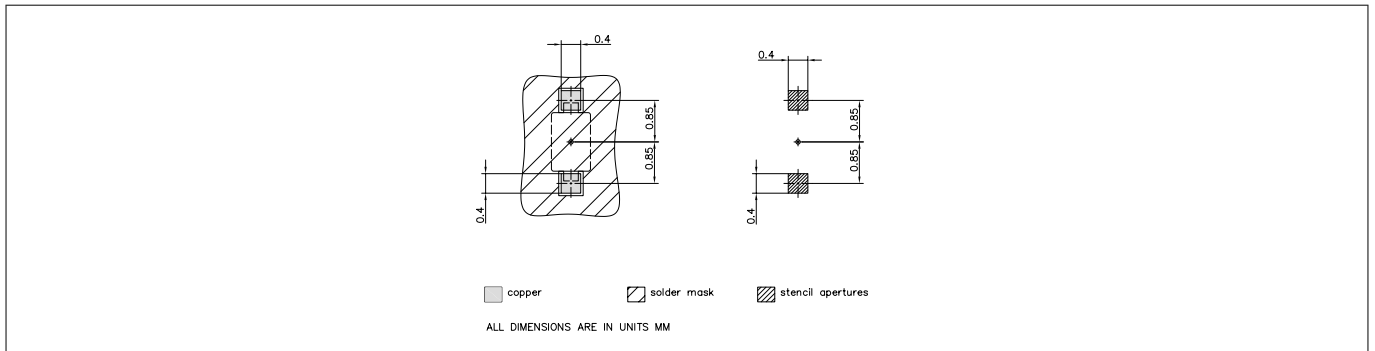
**Figure 9 Permissible forward current ratio  $I_{Fmax} / I_{DC}$  in pulse operation**

Package information SC79

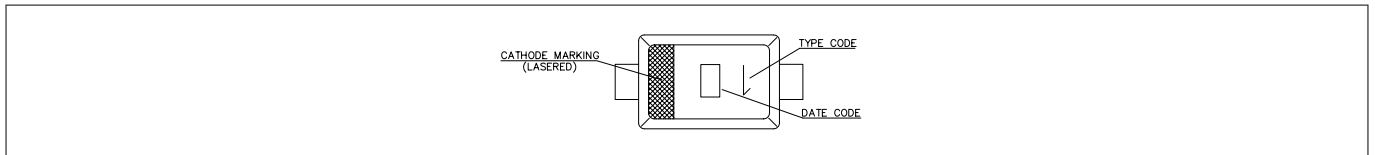
## 4 Package information SC79



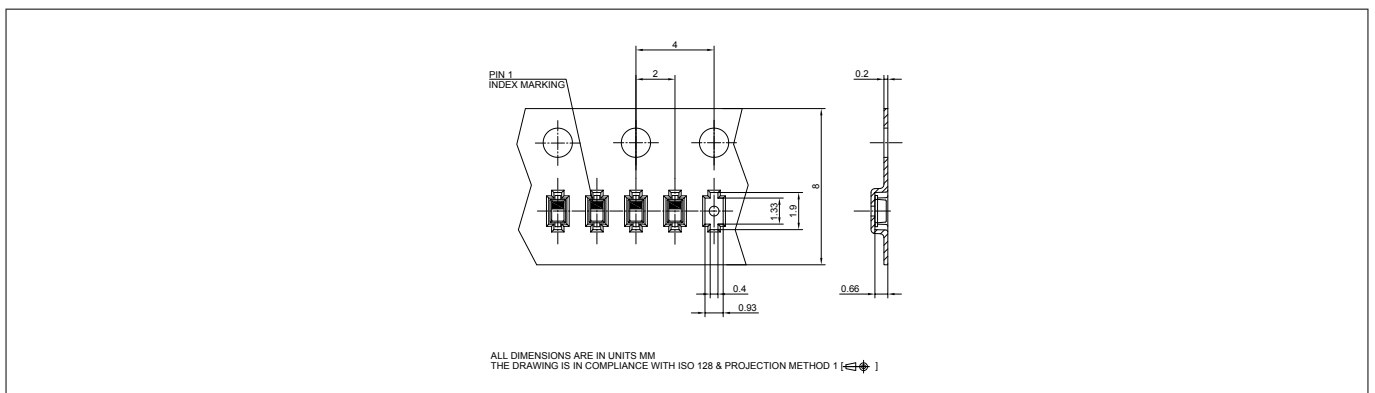
**Figure 10** Package outline



**Figure 11** Foot print



**Figure 12** Marking layout



**Figure 13** Tape dimensions

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Revision history

## Revision history

Document version	Date of release	Description of changes
1.0	2018-09-07	<ul style="list-style-type: none"><li>• Change from series datasheet to individual one</li><li>• Initial release of datasheet</li><li>• Typical values and curves updated to the values of the production (No product or process change behind)</li><li>• Maximum/typical values added</li><li>• Typical curves/values removed</li></ul>

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**Edition 2018-06-30**

**Published by**  
**Infineon Technologies AG**  
**81726 Munich, Germany**

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**IFX-pmi1535438451692**

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